



BZX84C43 - BZX84C51

350mW SURFACE MOUNT ZENER DIODE

Features

- Planar Die Construction
- 350mW Power Dissipation
- Zener Voltages from 43V 51V
- Ideally Suited for Automated Assembly Processes
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 6)

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)



Device Schematic

Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Cha	aracteristic	Symbol	Value	Unit	
Forward Voltage	@ I _F = 10mA	VF	0.9	V	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	PD	300	mW
Power Dissipation (Note 2)	PD	350	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	$R_{ heta JA}$	417	°C/W
Thermal Resistance, Junction to Ambient Air (Note 2)	$R_{ heta JA}$	357	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +150	٥°

Electrical Characteristics @T_A = 25°C unless otherwise specified

Type Number	Type Code	Zener Voltage Range (Note 5)				Maximum Zener Impedance (Note 4)			Maximum Reverse Current (Note 5)		Typical Temperature Coefficient @ Iz⊤ mV/°C	
		Vz@lzt Izt		Izt	Z _{ZT} @ I _{ZT} Z _{ZK} @ I _{ZK}		I _R	VR	Min	Max		
		Nom (V)	Min (V)	Max (V)	(mA)	(Ω)	(Ω)	(mA)	(μΑ)	(V)		Max
BZX84C43	Y15/KYF	43	40.0	46.0	2.0	150	375	0.5	0.1	30.1	10.0	12.0
BZX84C47	Y16/KYG	47	44.0	50.0	2.0	170	375	0.5	0.1	32.9	10.0	12.0
BZX84C51	Y17/KYH	51	48.0	54.0	2.0	180	400	0.5	0.1	35.7	10.0	12.0

Notes: 1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at

http://www.diodes.com/datasheets/ap02001.pdf.

2. Valid provided the terminals are kept at ambient temperature.

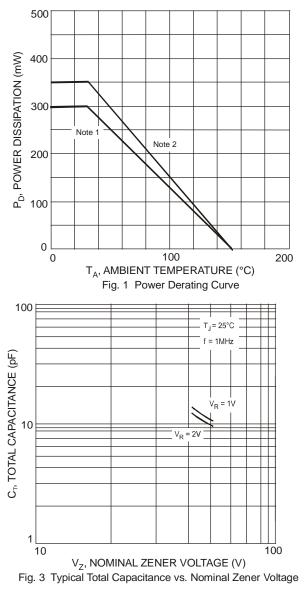
3. No purposefully added lead. Halogen and Antimony Free.

5. Short duration pulse test used to minimize self-heating effect.

 Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

^{4.} f = 1KHz.





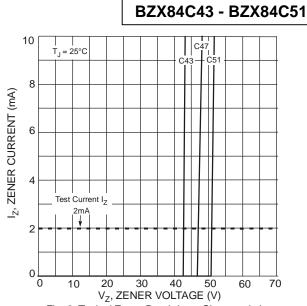


Fig. 2 Typical Zener Breakdown Characteristics

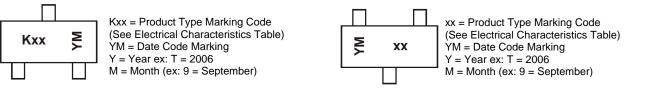
Ordering Information (Note 7)

Part Number	Case	Packaging		
(Type Number)-7-F*	SOT-23	3000/Tape & Reel		

*Add "-7" to the appropriate type number in Electrical Characteristics Table on Page 2. Example: 43V Zener = BZX84C43-7-F.

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



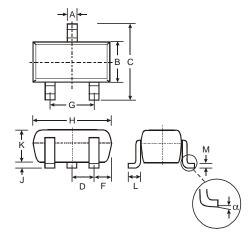
Date Code Key

Year	2006	2007	20	08	2009	2010	2011	2012	20	13	2014	2015
Code	Т	U	١	/	W	Х	Y	Z	1	4	В	С
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



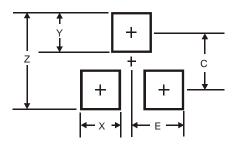
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Package Outline Dimensions



	SOT-23						
Dim	Min	Max					
Α	0.37	0.51					
В	1.20	1.40					
С	2.30	2.50					
D	0.89	1.03					
F	0.45	0.60					
G	1.78	2.05					
Н	2.80	3.00					
J	0.013	0.10					
Κ	0.903	1.10					
L	0.45	0.61					
М	0.085	0.180					
α	0°	8°					

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35

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